

## U.S. PATENT AND TRADEMARK OFFICE

Form PTO-1595

U.S. Department of Commerce

**RECORDATION FORM COVER SHEET - PATENTS ONLY**

To the Honorable Commissioner of Patents and Trademarks. Please record the attached original documents or copy thereof.

1. Name of conveying party(ies):		2. Name and Address of receiving Party(ies):	
a) <u>Levi A. Campbell</u>	f) <u>Robert E. Simons</u>	Name: INTERNATIONAL BUSINESS MACHINES CORPORATION	
b) <u>Richard C. Chu</u>	g) _____	Address: New Orchard Road,	
c) <u>Michael J. Ellsworth, Jr.</u>	h) _____	Armonk, NY 10504	
d) <u>Madhusudan K. Iyengar</u>	i) _____		
e) <u>Roger R. Schmidt</u>	j) _____		
More names attached? <u>Y</u> <u>X</u> N		More names attached? <u>Y</u> <u>X</u> N	
3. Nature of Conveyance: <u>X</u> Assignment			
4. Application number: <u>11/420,241</u> Filed: <u>May 25, 2006</u>			
Filed with new application: Yes _____ No <u>X</u>			
Execution date(s):			
a) <u>May 23, 2006</u>	f) <u>May 23, 2006</u>		
b) <u>May 22, 2006</u>	g) _____		
c) <u>May 23, 2006</u>	h) _____		
d) <u>May 24, 2006</u>	i) _____		
e) <u>May 22, 2006</u>	j) _____		
5. Name and address of party to whom correspondence concerning document should be mailed:		6. Total # of applications and patents involved: <u>01</u>	
Lily Neff			
IBM Corporation - P386		7. Total fee (37 CFR 3.41):	
Intellectual Property Law		<u>\$ 40.00</u>	
2455 South Road,		8. Charge to Deposit Account	
Poughkeepsie, NY 12601		<u>09-0463</u>	

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9. Statement and Signature: To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Name Sandra L. Kilmer Signature Sandra L. Kilmer Date June 27, 2006

RETURN FAX NO. (845) 432-9601

Total # of pages comprising cover sheet, attachments, and document: 3

Express Mail Label: (if applicable) \_\_\_\_\_ Docket No. POU920050130US1

This document and attachments are being deposited in the US PTO Assignment Branch at Fax No. (571) 273-0140 on 6/27/2006

## ASSIGNMENT

Whereas, we

- |     |   |   |
|-----|---|---|
| (1) | Levi A. Campbell<br>County of Ulster            | of New Paltz<br>State of New York         |
| (2) | Richard C. Chu<br>County of Dutchess            | of Hopewell Junction<br>State of New York |
| (3) | Michael J. Ellsworth, Jr.<br>County of Dutchess | of Lagrangeville<br>State of New York     |
| (4) | Madhusudan K. Iyengar<br>County of Ulster       | of Woodstock<br>State of New York         |
| (5) | Roger R. Schmidt<br>County of Dutchess          | of Poughkeepsie<br>State of New York      |
| and |   |   |
| (6) | Robert E. Simons<br>County of Dutchess          | of Poughkeepsie<br>State of New York      |

have invented certain improvements in

**COOLING APPARATUS, COOLED ELECTRONIC MODULE  
AND METHODS OF FABRICATION THEREOF EMPLOYING A  
THERMALLY CONDUCTIVE RETURN MANIFOLD STRUCTURE  
SEALED TO THE PERIPHERY OF A SURFACE TO BE COOLED**

and executed a United States Patent Application therefore on

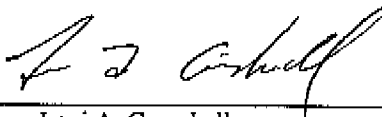
- (1) May 23, 2006, (2) May 22, 2006, (3) May 23, 2006, (4) May 24, 2006,  
(5) May 22, 2006, and (6) May 23, 2006.

Whereas, INTERNATIONAL BUSINESS MACHINES CORPORATION, a corporation of New York, having a place of business at New Orchard Road, Armonk, New York, 10504, (hereinafter called IBM), desires to acquire the entire right, title and interest in the said application and invention, and to any United States and foreign patents to be obtained therefore;

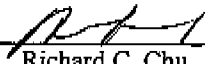
Now therefore, for a valuable consideration, receipt whereof is hereby acknowledged, we, the above named, hereby sell, assign and transfer to IBM, its successors and assigns, the entire right, title and interest in the said application and the invention therein disclosed for the United States and foreign countries, and all rights of priority resulting from the filing of said United States application, and we request the Commissioner of Patents to issue any Letters Patents granted upon the invention set forth in said application to IBM, its successors and assigns; and we hereby agree that IBM may apply for foreign Letters Patents on said invention and we will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by IBM.

Signed

(1) at Poughkeepsie, NY  
on 5/23/06

  
Levi A. Campbell

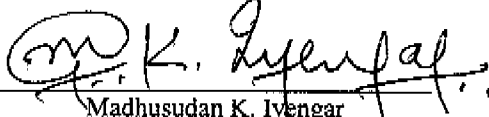
(2) at Poughkeepsie, NY  
on 5/22/06

  
Richard C. Chu

(3) at Poughkeepsie, NY  
on 5/23/2006

  
Michael J. Ellsworth, Jr.

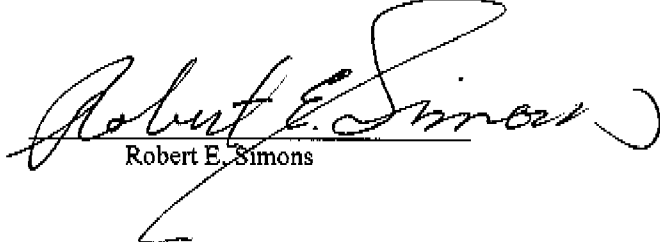
(4) at Poughkeepsie, NY  
on 5/24/06

  
Madhusudan K. Iyengar

(5) at Poughkeepsie, NY  
on 5/22/06

  
Roger R. Schmidt

(6) at Poughkeepsie, NY  
on 5/23/06

  
Robert E. Simons